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1. Name of C	Conveying Party(ies):	2. Name and Address of Receiving Party(ies):
Additional names 3. Nature of Assig	rity Agreement	Name: Hitachi, Ltd. Address: 6-6, Marunouchi I-chome, City: Chiyoda-ku, Tokyo, Japan
September 28,	Date: (1) (3) September 27, 2006 (2) 2006	
If this documer the execution d	Application Number(s): at is being filed together with a new application, ate of the application is:	4. (b) Patent Numbers:
☐ Additional	Numbers Attached.	
5. Name and Concerning thi	Address of Party to whom Correspondence s Document Should be Mailed:	6. Total Number of Applications and Patents Involved.
Name:	Stanley P. Fisher	7. Total Fee: \$40.00 (37 C.F.R. § 3.41)
Address:	Reed Smith LLP 3110 Fairview Park Dr. Suite 1400 Falls Church, VA. 22042	Enclosed.Authorized to be charged to deposit account.
	-	8. Deposit Account Number: 08-1480 ATTACH DUPLICATE COPY OF THIS PAGE IF PAYING BY DEPOSIT ACCOUNT
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0 Statemen	ETHIS SPACE It and Signature: st of my knowledge and belief, the foregoing is transment.	true and correct and any attached copy is a true copy of the November 20, 20
Stanley P. Fis	her, Registration No. 24, 344	Rian Carlos A. Marquez, Registration No. 34
	of pages comprising cover sheet: 1	

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ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI, LTD., a corporation organized under the laws of Japan, located at 6-6, Marunouchi 1-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

SMALL SIZE GENE ANALYSIS APPARATUS

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI, LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI, LTD.

Signed on the date(s) indicated aside signatures:

	INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1)	Lomohare Hagyania Nicles: Kambara	9/27/2006
2)	Wieleh: Kambara Hideki KAMBARA	
3)	Hideki KAMBARA Kunice Harada Kunio HARADA	9/27/2006
4)		
5)		
6)		
7)		
8)		
9)		
10)		

PATENT REEL: 018617 FRAME: 0579

RECORDED: 11/20/2006